

N-channel 30 V 2.1 m Ω logic level MOSFET

Rev. 01 — 24 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

 High efficiency due to low switching and conduction losses

1.3 Applications

- DC-to-DC converters
- Load switiching

1.4 Quick reference data

 Suitable for logic level gate drive sources

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- Motor control
- Server power supplies

| Table 1. | Quick reference | | | | | | |
|---------------------|-------------------------------------|--|-----|-----|-----|-----|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | | - | - | 30 | V |
| I _D | drain current | $T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> | [1] | - | - | 100 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | | - | - | 211 | W |
| Dynamic | characteristics | | | | | | |
| Q _{GD} | gate-drain charge | V_{GS} = 4.5 V; I _D = 25 A; | | - | 16 | - | nC |
| Q _{G(tot)} | total gate charge | V _{DS} = 12 V; see <u>Figure 13;</u> see <u>Figure 14</u> | | - | 55 | - | nC |
| Static ch | aracteristics | | | | | | |
| R_{DSon} | drain-source on-state resistance | $\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 15 \text{ A}; \\ T_{j} = 25 \text{ °C} \end{array}$ | | - | 2 | 2.8 | mΩ |
| | | V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u> | [2] | - | 1.7 | 2.1 | mΩ |
| | | | | | | | |

[1] Continuous current is limited by package.

[2] Measured 3 mm from package.

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2. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|--------------------------------------|---------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | G | gate | | |
| 2 | D | drain | mb | |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | mbb076 S |
| | | | SOT78 (TO-220AB) | |

3. Ordering information

Table 3.Ordering information

| Type number Package | | | |
|---------------------|----------|--|---------|
| | Name | Description | Version |
| PSMN2R0-30PL | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

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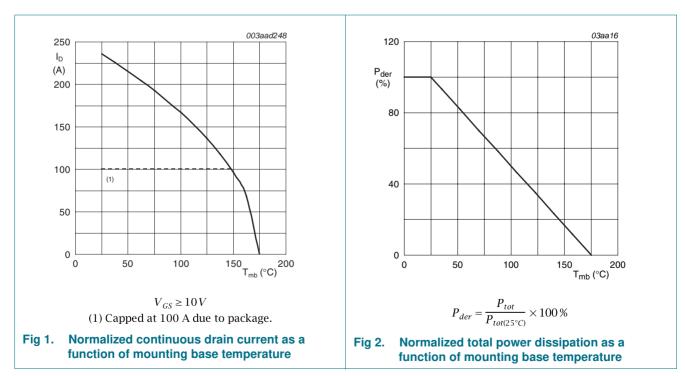
4. Limiting values

Table 4.Limiting values

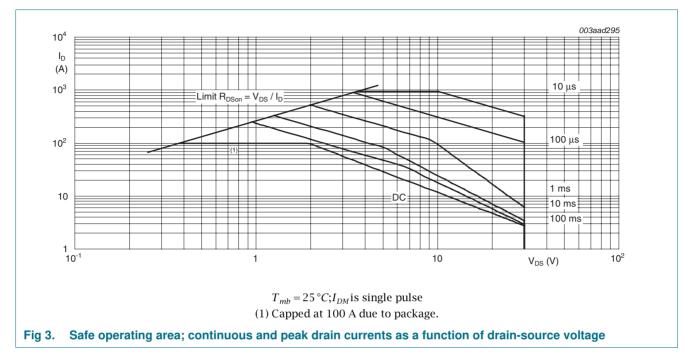
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|--|--|-----|-----|-----|------|
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | | - | 30 | V |
| V _{DGR} | drain-gate voltage | $T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$ | | - | 30 | V |
| V _{GS} | gate-source voltage | | | -20 | 20 | V |
| I _D | drain current | V_{GS} = 10 V; T_{mb} = 100 °C; see <u>Figure 1</u> | [1] | - | 100 | А |
| | | V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u> | [1] | - | 100 | А |
| I _{DM} | peak drain current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3 | | - | 943 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | | - | 211 | W |
| T _{stg} | storage temperature | | | -55 | 175 | °C |
| Tj | junction temperature | | | -55 | 175 | °C |
| Source-dr | ain diode | | | | | |
| I _S | source current | T _{mb} = 25 °C | [1] | - | 100 | А |
| I _{SM} | peak source current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$ | | - | 943 | А |
| Avalanche | e ruggedness | | | | | |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_{D} = 100 A; V_{sup} ≤ 30 V; R_{GS} = 50 $\Omega;$ unclamped | | - | 555 | mJ |

[1] Continuous current is limited by package.



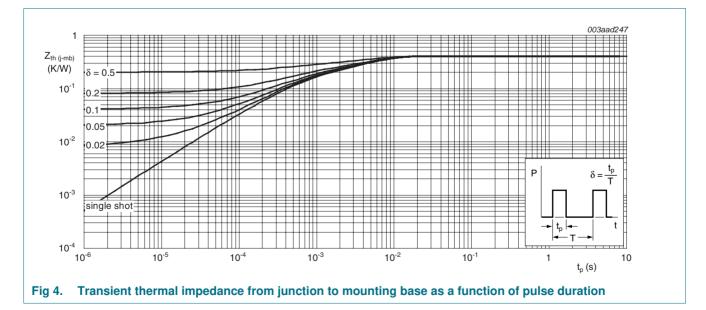
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5. Thermal characteristics

| Table 5. | Thermal | characteristics |
|----------|---------|-----------------|
|----------|---------|-----------------|

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|---------------------|-----|------|------|------|
| $R_{\text{th(j-mb)}}$ | thermal resistance from junction to mounting base | see <u>Figure 4</u> | - | 0.41 | 0.71 | K/W |



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6. Characteristics

| Table 6. | Characteristics | | | | | | |
|------------------------|--------------------------------------|--|-----|-----|------|------|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| Static cha | racteristics | | | | | | |
| V _{(BR)DSS} | drain-source | $I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$ | | 30 | - | - | V |
| | breakdown voltage | $I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$ | | 27 | - | - | V |
| V _{GS(th)} | gate-source threshold voltage | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 9</u> ; see <u>Figure 10</u> | | 1.3 | 1.7 | 2.15 | V |
| | | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 10</u> | | 0.5 | - | - | V |
| | | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 10</u> | | - | - | 2.45 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | | - | - | 3 | μA |
| | | $V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$ | | - | - | 70 | μA |
| I _{GSS} | gate leakage current | V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C | | - | - | 100 | nA |
| | | $V_{GS} = -16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | | - | - | 100 | nA |
| R _{DSon} | drain-source on-state | V_{GS} = 4.5 V; I_{D} = 15 A; T_{j} = 25 °C | | - | 2 | 2.8 | mΩ |
| | resistance | V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; see <u>Figure 11</u> | | - | - | 3 | mΩ |
| | | V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u> | [2] | - | 1.7 | 2.1 | mΩ |
| R _G | gate resistance | f = 1 MHz | | - | 0.78 | - | Ω |
| Dynamic | characteristics | | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 13</u> ; see <u>Figure 14</u> | | - | 117 | - | nC |
| | | $I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$ see Figure 13; see Figure 14 | | - | 55 | - | nC |
| Q _{GS} | gate-source charge | $I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$ | | - | 17 | - | nC |
| Q _{GS(th)} | pre-threshold gate-source charge | see <u>Figure 13;</u> see <u>Figure 14</u> | | - | 11 | - | nC |
| Q _{GS(th-pl)} | post-threshold gate-source charge | | | - | 6 | - | nC |
| Q _{GD} | gate-drain charge | | | - | 16 | - | nC |
| V _{GS(pl)} | gate-source plateau voltage | V_{DS} = 12 V; see <u>Figure 13</u> ; see <u>Figure 14</u> | | - | 2.6 | - | V |
| C _{iss} | input capacitance | V_{DS} = 12 V; V_{GS} = 0 V; f = 1 MHz; | | - | 6810 | - | pF |
| C _{oss} | output capacitance | $T_j = 25 \text{ °C}; \text{ see } Figure 15$ | | - | 1410 | - | pF |
| C _{rss} | reverse transfer capacitance | | | - | 650 | - | pF |
| t _{d(on)} | turn-on delay time | V_{DS} = 12 V; R_L = 0.5 Ω; V_{GS} = 4.5 V; | | - | 63 | - | ns |
| t _r | rise time | $R_{G(ext)} = 4.7 \ \Omega$ | | - | 125 | - | ns |
| t _{d(off)} | turn-off delay time | | | - | 111 | - | ns |
| t _f | fall time | | | - | 59 | - | ns |

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PSMN2R0-30PL

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| | ed | | | | | |
|---|--|--|---|--|--|---|
| Parameter | Conditions | | Min | Тур | Max | Unit |
| ain diode | | | | | | |
| source-drain voltage | $I_{S} = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C};$ see <u>Figure 16</u> | | - | 0.76 | 1.2 | V |
| reverse recovery time | | _S = 0 V; | - | 49 | - | ns |
| recovered charge | $V_{DS} = 30 V$ | | - | 66 | - | nC |
| to JEDEC standards where a ed 3 mm from package. | oplicable. | | | | | |
| 0 0.5 1 | | 80 | 2 | | 003aad254 | |
| | | | aracteristic | s: drain | | |
| | | | | | 003aad251 | |
| | | | | | | |
| | | 4 | | | | |
| | | 4 | | | | |
| | recovered charge to JEDEC standards where an ed 3 mm from package. | reverse recovery time recovered charge to JEDEC standards where applicable. ed 3 mm from package. 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 10 003aad249 10 003aad249 10 003aad249 10 003aad249 10 10 10 10 10 10 10 10 | reverse recovery time $I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A}/\mu\text{s}$; $V_{GS} = 0 \text{ V}$; recovered charge $V_{DS} = 30 \text{ V}$ to JEDEC standards where applicable. ed 3 mm from package. | reverse recovery time $I_{\rm S} = 20$ A; dIs/dt = -100 A/µs; V _{GS} = 0 V; recovered charge $V_{\rm DS} = 30$ V | reverse recovery time $l_{\rm S} = 20$ A; dl _S /dt = -100 A/µs; V _{GS} = 0 V; - 49 recovered charge $V_{\rm DS} = 30$ V - 66 to JEDEC standards where applicable. ed 3 mm from package. | reverse recovery time $I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A}/\mu\text{s}$; $V_{GS} = 0 \text{ V}$; $-49 - 66 - 66 - 66 - 66 - 66 - 66 - 66 -$ |

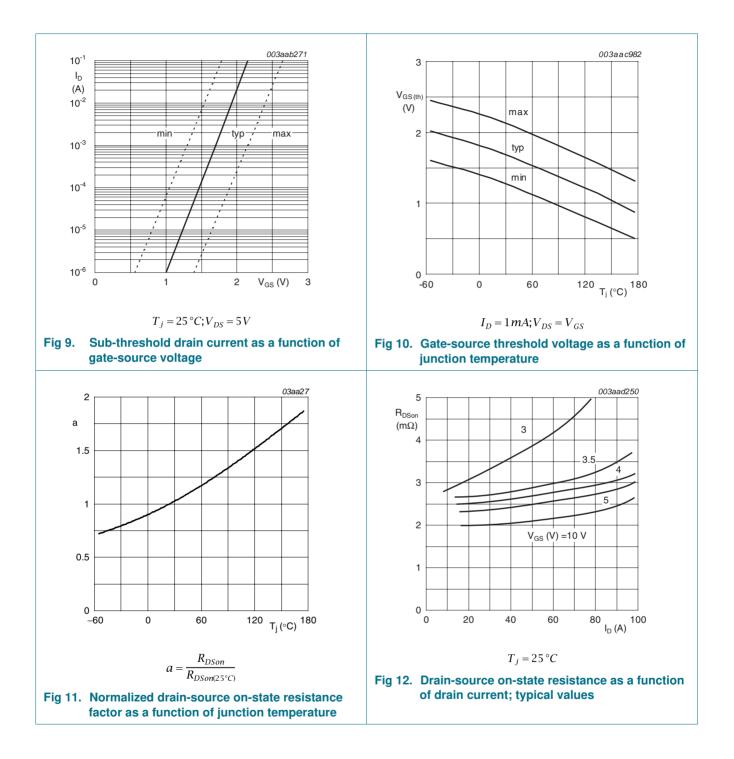
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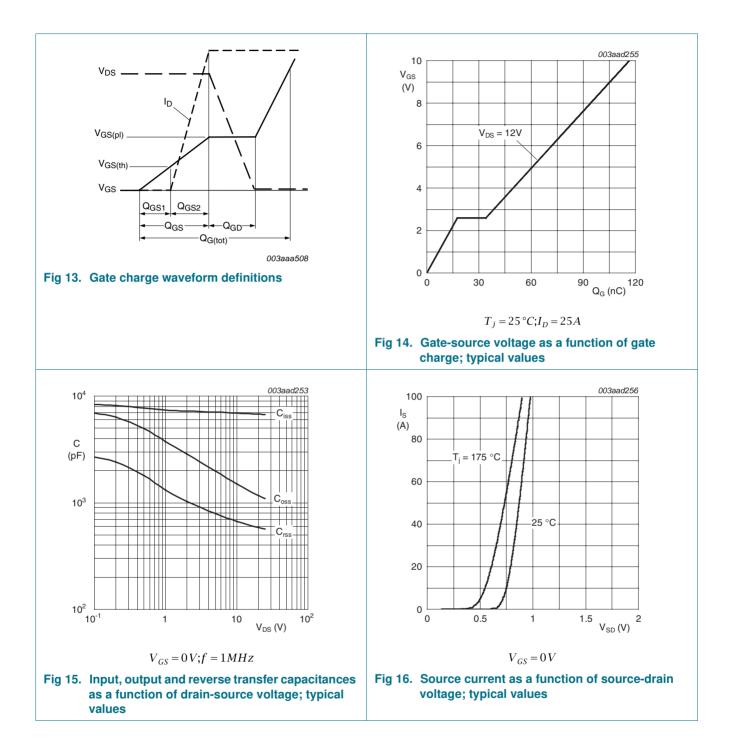
drain current; typical values

of gate-source voltage; typical values

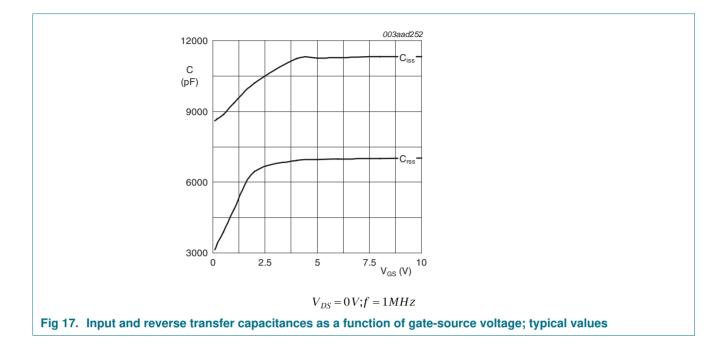
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7. Package outline

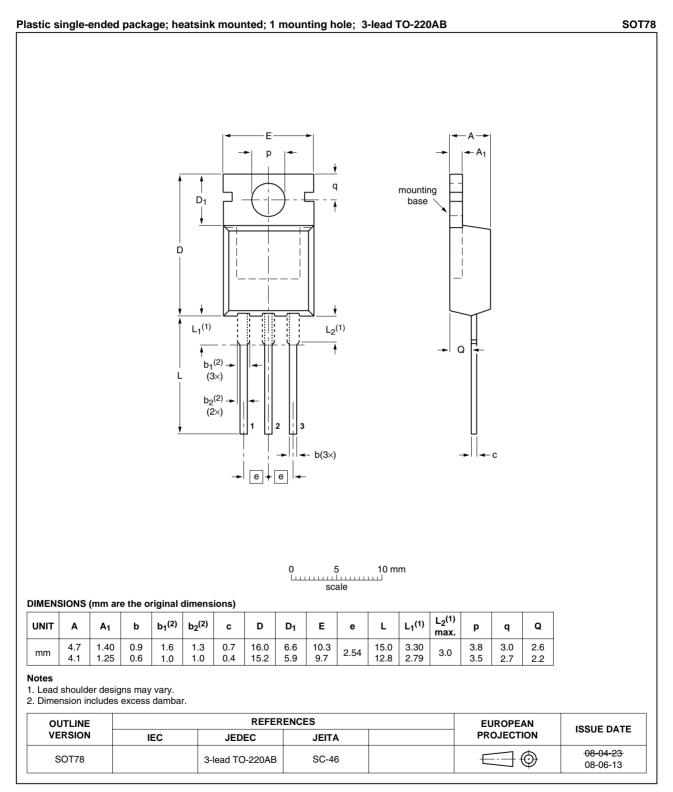


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

| Table 7. Revision hist | Revision history | | | | | |
|------------------------|------------------|--------------------|---------------|------------|--|--|
| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
| PSMN2R0-30PL_1 | 20090624 | Product data sheet | - | - | | |

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9. Legal information

9.1 Data sheet status

| Document status [1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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